

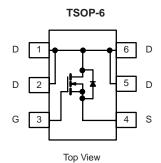
UT3458-VB Datasheet N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.030			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.035			
I _D (A)	7			
Configuration	Single			

FEATURES

- Trench power MOSFET
- 100 % R_g and UIS tested





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V _{GS}	V _{GS} ± 20	
Continuous Drain Current	T _C = 25 °C	- I _D	7	
	T _C = 125 °C		4	
Continuous Source Current (Diode Conduction)		I _S	6	Α
Pulsed Drain Current ^a		I _{DM}	29	
Single Pulse Avalanche Current	L = 0.1 mH	las	10	
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	5	mJ
Maximum Power Dissipation ^a	T _C = 25 °C	- P _D	5	W
	T _C = 125 °C		1.6	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount b	R _{thJA}	110	°C/W	
Junction-to-Foot (Drain)		R_{thJF}	30	C/VV	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. When mounted on 1" square PCB (FR-4 material).

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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		60	-	-	V	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	2.5	V	
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V		-	-	± 500	nA	
		V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 1	mA	
Zero Gate Voltage Drain Current		V _{GS} = 0 V	V _{DS} = 60 V	=	-	1		
	I _{DSS}	V _{GS} = 0 V	V _{DS} = 60 V, T _J = 125 °C	-	-	50	μΑ	
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 175 °C	=	-	150		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	10	-	-	Α	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 5 A	-	0.030	-	Ω	
	Б	V _{GS} = 10 V	I _D = 5 A, T _J = 125 °C	-	0.050	-		
	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A, T _J = 175 °C	-	0.070	-		
		V _{GS} = 4.5 V	I _D = 4 A	-	0.035	-		
Forward Transconductance a	9 _{fs}	V _{DS}	= 15 V, I _D = 4 A	-	12	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}		V _{DS} = 30 V, f = 1 MHz	-	560	700	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	85	105		
Reverse Transfer Capacitance	C _{rss}			-	55	70		
Total Gate Charge ^c	Qg	V _{GS} = 4.5 V	V _{DS} = 30 V, I _D = 4 A	-	7.6	12	nC	
Gate-Source Charge c	Q _{gs}			-	2.1	-		
Gate-Drain Charge ^c	Q _{gd}	1		-	4.1	-		
Gate Resistance	R _g	f = 1 MHz		1.2	2.4	3.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	9	14		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 7.5 Ω I_D \cong 4 A, V_{GEN} = 10 V, R_g = 1 Ω		-	12	18	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	19	29		
Fall Time ^c	t _f			-	7	11		
Source-Drain Diode Ratings and Characte	eristics ^b							
Pulsed Current ^a	I _{SM}			ı	-	29	Α	
Forward Voltage	V _{SD}	I _F = 1.6 A, V _{GS} = 0		-	0.75	1.2	V	

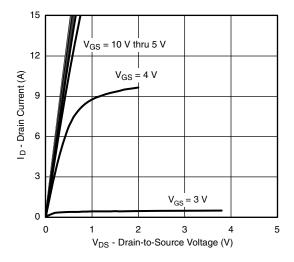
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

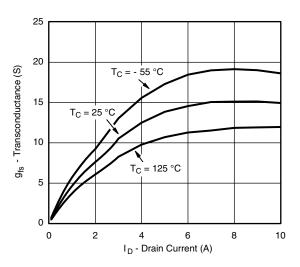
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



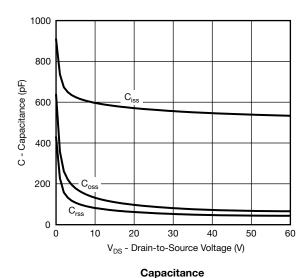
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

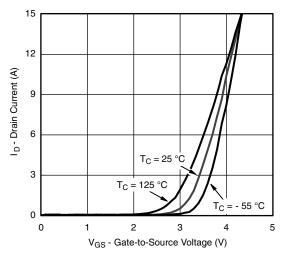


Output Characteristics

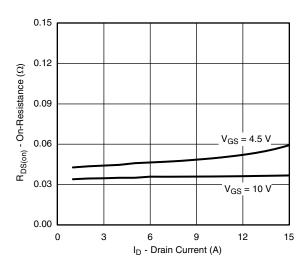


Transconductance

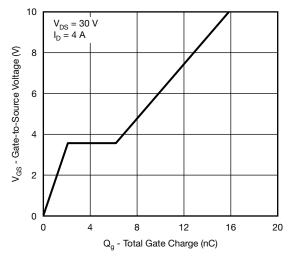




Transfer Characteristics



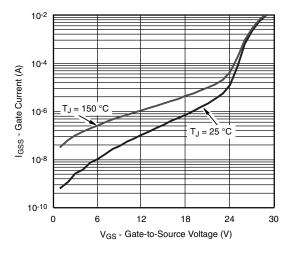
On-Resistance vs. Drain Current



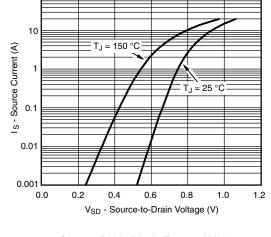
Gate Charge



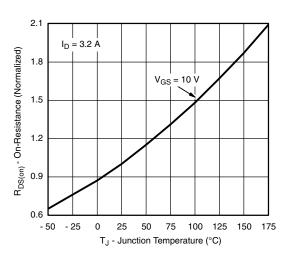
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



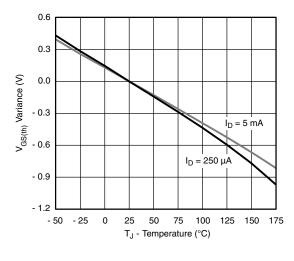
Gate Current vs. Gate-Source Voltage



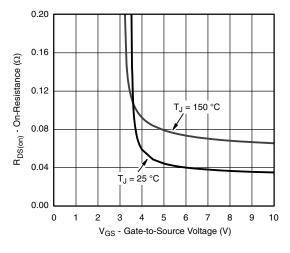
Source-Drain Diode Forward Voltage



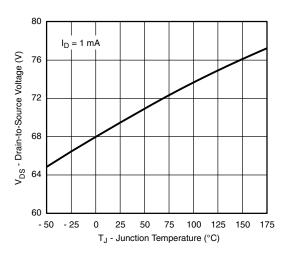
On-Resistance vs. Junction Temperature



Threshold Voltage



On-Resistance vs. Gate-Source Voltage

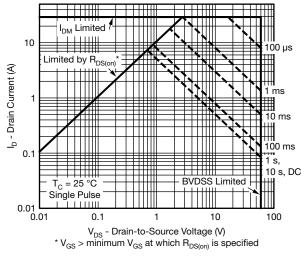


Drain-Source Breakdown vs. Junction Temperature

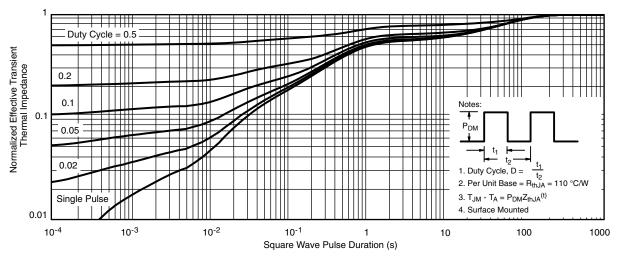


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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



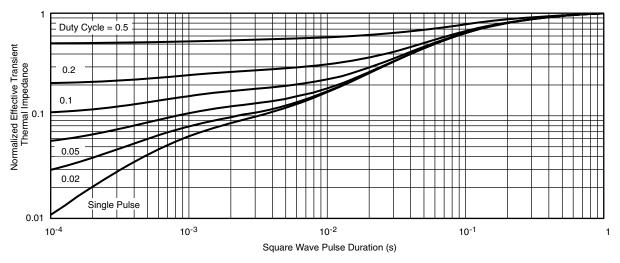
Safe Operating Area



Normalized thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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